






**Modified epoxy resins.**

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**Cited documents:**

 EP0245018  
 US3856883  
 EP0191872

**Abstract of EP0449776**

Epoxy resin compositions containing

- a) at least one epoxy resin containing on average more than one 1,2-epoxide group per molecule,
- b) an anhydride curing agent for the epoxy resin a),
- c) a toughness improver and
- d) a compound containing two active hydrogen atoms which is capable of reacting with the epoxy resin a),

have excellent toughness and are suitable as casting resins, laminating resins, compression-moulding compounds, coating compositions and encapsulating systems for electrical and electronic components.

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